

FQD19N10L N-Channel QFET[®] MOSFET 100 V, 15.6 A, 100 mΩ

Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

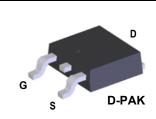
Features

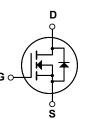
• 15.6 A, 100 V, $R_{DS(on)}$ = 100 m Ω (Max.) @ V_{GS} = 10 V

FQD19N10L N-Channel QFET[®] MOSFET

March 2013

- Low Gate Charge (Typ. 14 nC)
- Low Crss (Typ. 35 pF)
- 100% Avalanche Tested





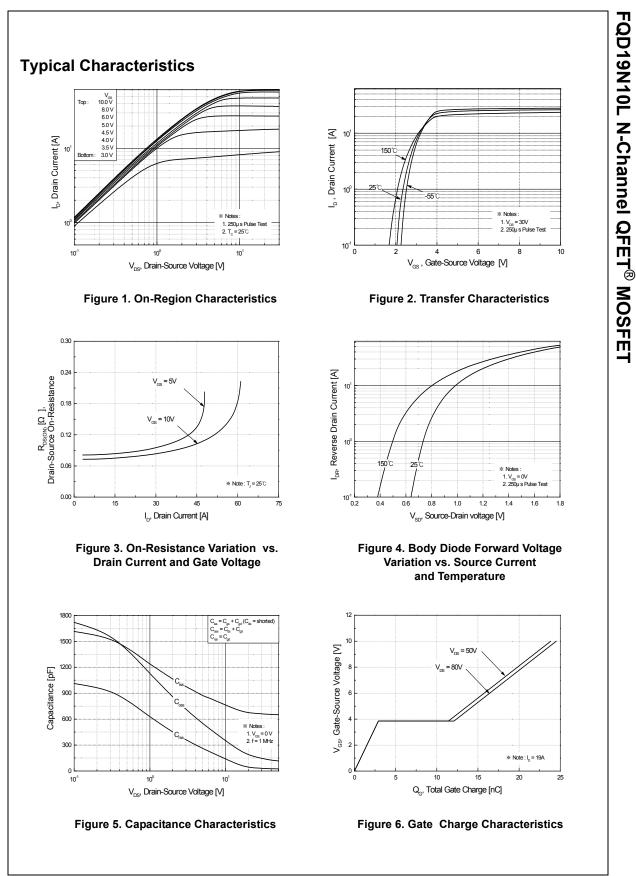
Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter		FQD19N10L	Unit	
V _{DSS}	Drain-Source V	rain-Source Voltage		100	V
I _D	Drain Current - Continuous (T _C = 25°C)		°C)	15.6	А
		- Continuous (T _C = 10	O°C)	9.8	А
I _{DM}	Drain Current	- Pulsed	(Note 1)	62.4	A
V _{GSS}	Gate-Source Voltage			± 20	V
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	220	mJ
I _{AR}	Avalanche Current		(Note 1)	15.6	А
E _{AR}	Repetitive Avala	anche Energy	(Note 1)	5.0	mJ
dv/dt	Peak Diode Re	covery dv/dt	(Note 3)	6.0	V/ns
P _D	Power Dissipation (T _A = 25°C) *			2.5	W
	Power Dissipation (T _C = 25°C)			50	W
	- Derate above 25°C			0.4	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		nge	-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		g purposes,	300	°C

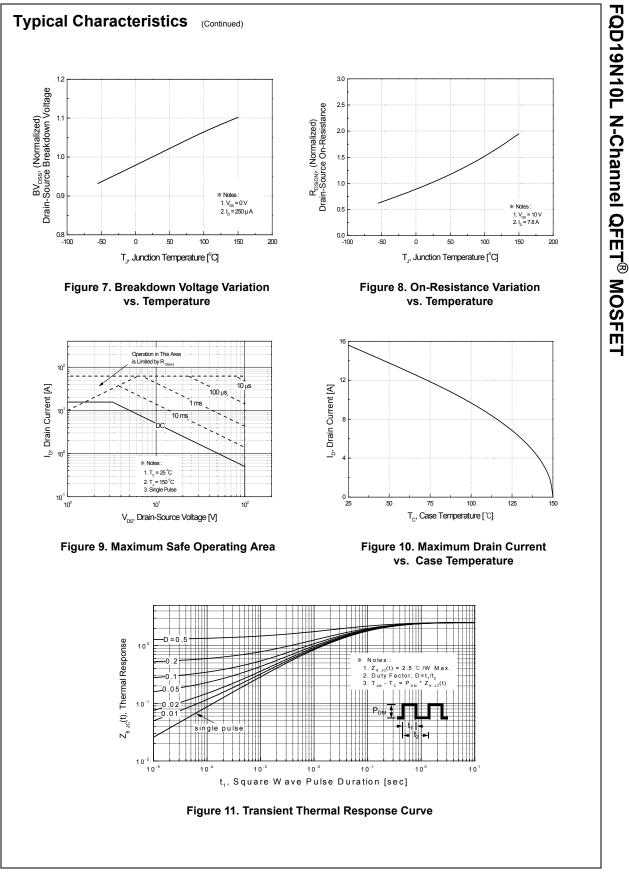
Thermal Characteristics

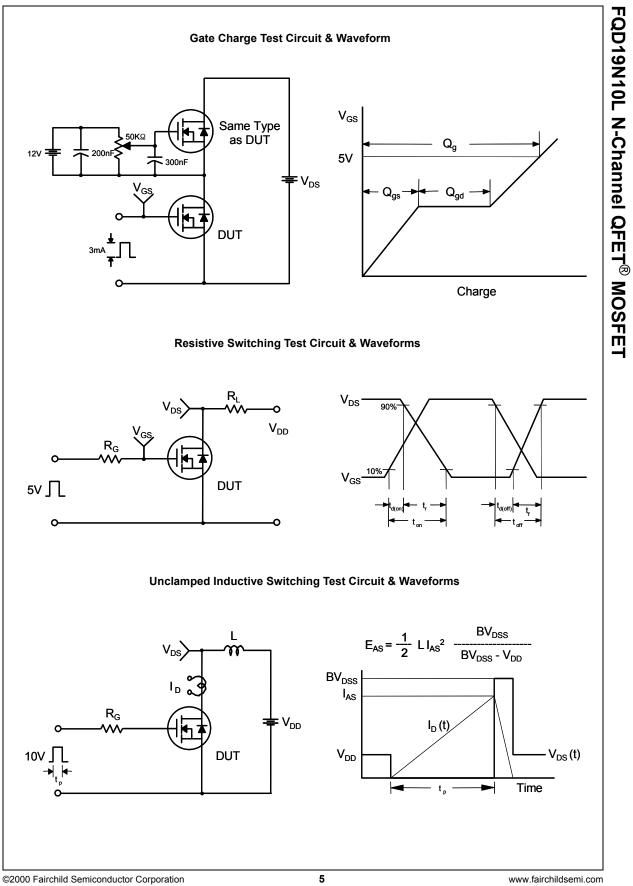
Symbol	Parameter	FQD19N10L	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.5	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient *	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	

BV _{DSS} ΔBV _{DSS} ΔΔT _J DSS	racteristics Drain-Source Breakdown Voltage					Unit
BV _{DSS} ΔBV _{DSS} ΔΔT _J DSS						
I _{DSS}	Dialii-Source Breakuowii Vollage	V _{GS} = 0 V, I _D = 250 μA	100			V
	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		0.09		V/°C
المعمد	Zara Cata Valtaga Drain Current	V _{DS} = 100 V, V _{GS} = 0 V			1	μA
lagar	Zero Gate Voltage Drain Current	V _{DS} = 80 V, T _C = 125°C			10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -20 V, V_{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	1.0		2.0	V
R _{DS(on)}	Static Drain-Source	V _{GS} = 10 V, I _D = 7.8 A		0.074	0.10	
DO(011)	On-Resistance	V _{GS} = 5 V, I _D = 7.8 A		0.082	0.11	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 30 V, I _D = 7.8 A		14		S
Dunomi	a Characteriatica					
C _{iss}	ic Characteristics	acitance $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ apacitancef = 1.0 MHz		670	870	pF
C _{oss}	Output Capacitance			160	210	pF
C _{rss}	Reverse Transfer Capacitance			35	45	pF
Switchi						
Switchi						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 50 V, I _D = 19 A,		14	38	ns
t _{d(on)} t _r	Turn-On Delay Time Turn-On Rise Time	$V_{DD} = 50 \text{ V}, \text{ I}_{D} = 19 \text{ A},$ R _G = 25 Ω		410	830	ns
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time			410 20	830 50	ns ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	R _G = 25 Ω		410 20 140	830 50 290	ns ns ns
t _{d(on)} t _r t _{d(off)} t _f Q _g	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$R_{G} = 25 \Omega$ V _{DS} = 80 V, I _D = 19 A,		410 20 140 14	830 50 290 18	ns ns ns nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$R_G = 25 \Omega$ V _{DS} = 80 V, I _D = 19 A, V _{GS} = 5 V	 	410 20 140 14 2.9	830 50 290 18 	ns ns nC nC
Switchi $t_{d(on)}$ t_r $t_{d(off)}$ t_f Q_g Q_{gs} Q_{gd} Drain-S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	R_{G} = 25 Ω V_{DS} = 80 V, I _D = 19 A, V_{GS} = 5 V (Note 4)		410 20 140 14	830 50 290 18	ns ns ns nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4)	 	410 20 140 14 2.9	830 50 290 18 	ns ns nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge ource Diode Characteristics an	$R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4) nd Maximum Ratings de Forward Current	 	410 20 140 14 2.9 9.2	830 50 290 18 	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge ource Diode Characteristics an Maximum Continuous Drain-Source Dio	$R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4) nd Maximum Ratings de Forward Current Forward Current	 	410 20 140 14 2.9 9.2	830 50 290 18 15.6	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _{gs} Q _{gd} Drain-S I _S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge ource Diode Characteristics al Maximum Continuous Drain-Source Diode F	$R_{G} = 25 \Omega$ $V_{DS} = 80 V, I_{D} = 19 A,$ $V_{GS} = 5 V$ (Note 4) nd Maximum Ratings de Forward Current Forward Current	 	410 20 140 14 2.9 9.2	830 50 290 18 15.6 62.4	ns ns nC nC nC

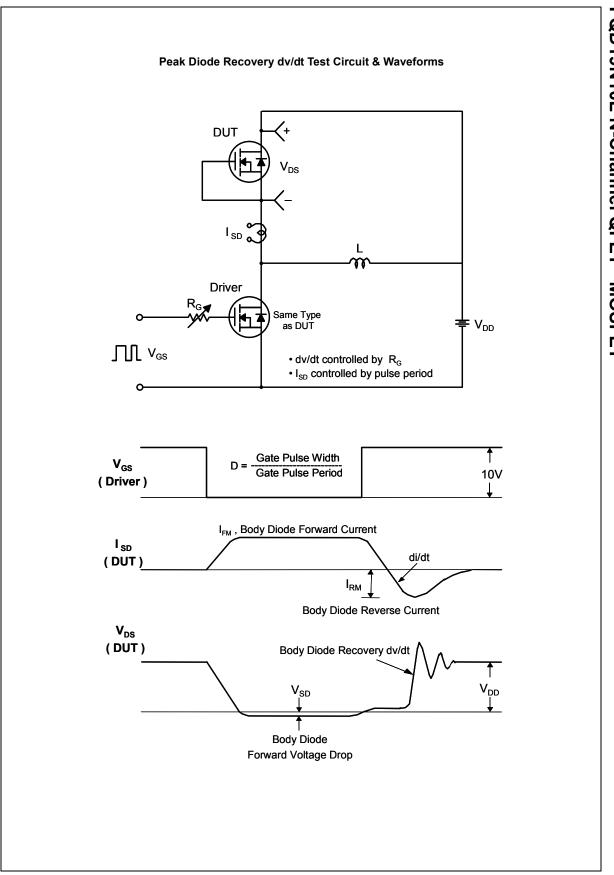


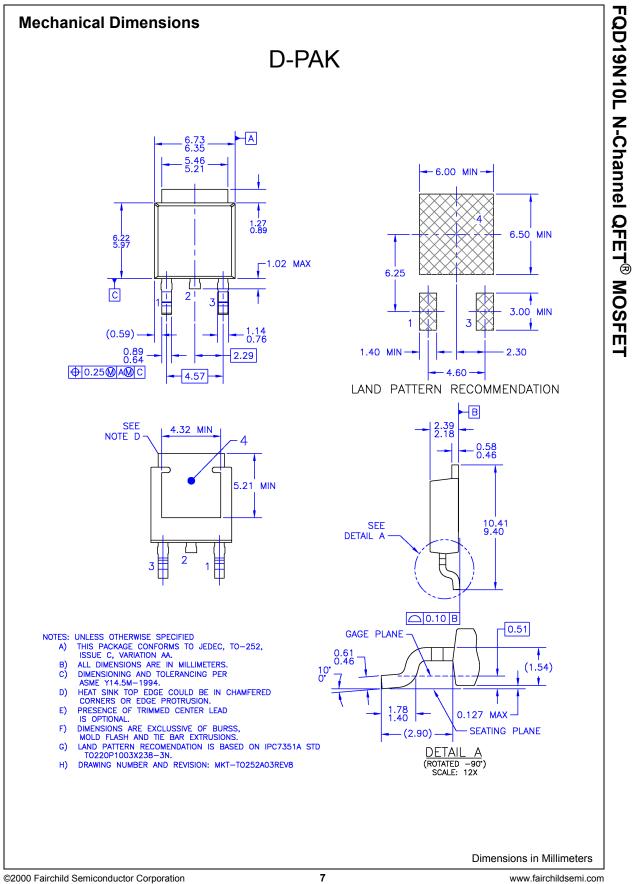
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